

# 2SA1619, 2SA1619A

## Silicon PNP epitaxial planar type

For low-frequency power amplification and driver amplification  
Complementary to 2SC4208 and 2SC4208A

### ■ Features

- Allowing supply with the radial tapering and automatic insertion possible

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	2SA1619	$V_{CBO}$	-30	V
	2SA1619A		-60	
Collector-emitter voltage (Base open)	2SA1619	$V_{CEO}$	-25	V
	2SA1619A		-50	
Emitter-base voltage (Collector open)	$V_{EBO}$	-5	V	
Collector current	$I_C$	-0.5	A	
Peak collector current	$I_{CP}$	-1	A	
Collector power dissipation	$P_C$	1	W	
Junction temperature	$T_j$	150	$^\circ\text{C}$	
Storage temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$	

### ■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

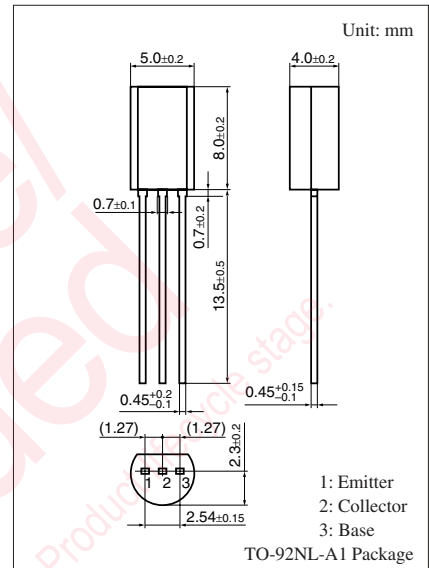
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base voltage (Emitter open)	2SA1619	$V_{CBO}$	$I_C = -10 \mu\text{A}, I_E = 0$	-30		V
	2SA1619A			-60		
Collector-emitter voltage (Base open)	2SA1619	$V_{CEO}$	$I_C = -10 \text{mA}, I_B = 0$	-25		V
	2SA1619A			-50		
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = -10 \mu\text{A}, I_C = 0$	-5			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = -20 \text{V}, I_E = 0$			-0.1	$\mu\text{A}$
Forward current transfer ratio *1	$h_{FE1}$ *2	$V_{CE} = -10 \text{V}, I_C = -150 \text{mA}$	85	160	340	—
	$h_{FE2}$	$V_{CE} = -10 \text{V}, I_C = -500 \text{mA}$	40	90		
Collector-emitter saturation voltage *1	$V_{CE(sat)}$	$I_C = -300 \text{mA}, I_B = -30 \text{mA}$		-0.35	-0.60	V
Base-emitter saturation voltage *1	$V_{BE(sat)}$	$I_C = -300 \text{mA}, I_B = -30 \text{mA}$		-1.1	-1.5	V
Transition frequency	$f_T$	$V_{CB} = -10 \text{V}, I_E = 50 \text{mA}, f = 200 \text{MHz}$		200		MHz
Collector output capacitance (Common base, input open circuited)	$C_{ob}$	$V_{CB} = -10 \text{V}, I_E = 0, f = 1 \text{MHz}$		6	15	pF

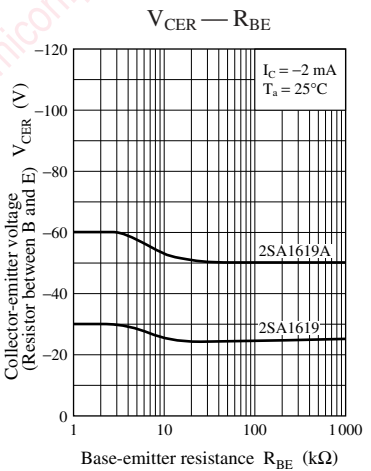
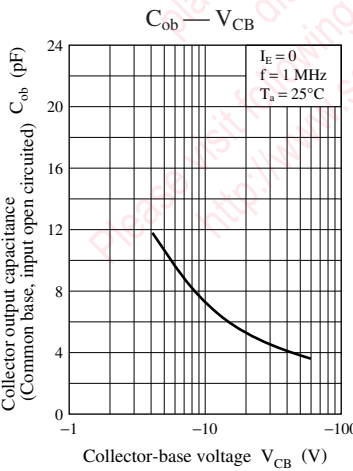
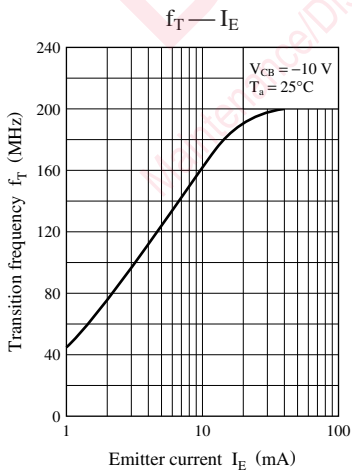
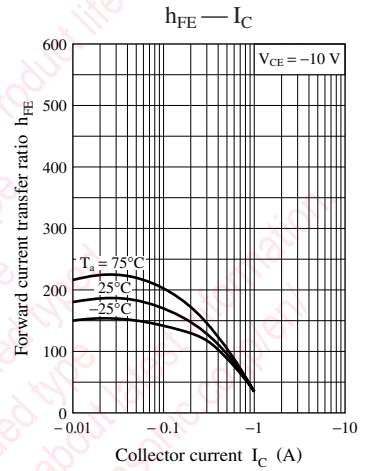
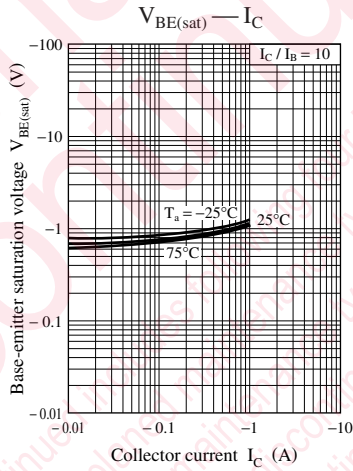
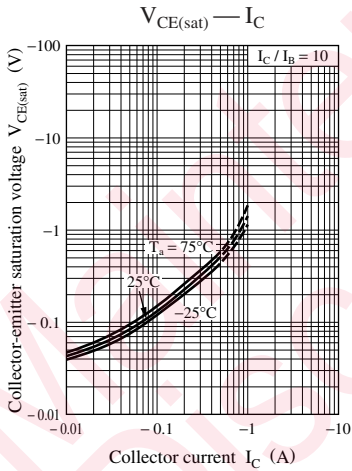
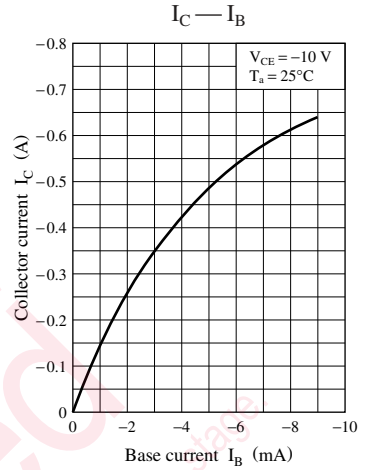
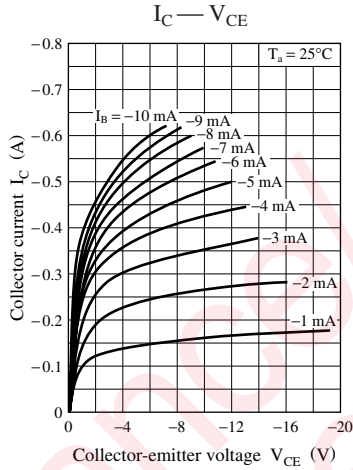
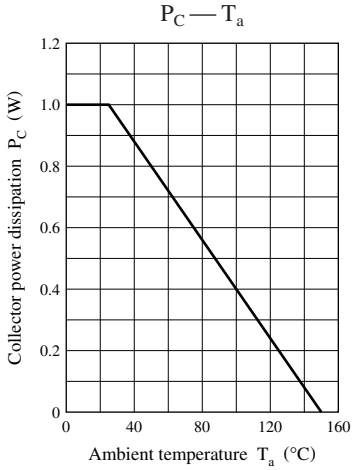
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

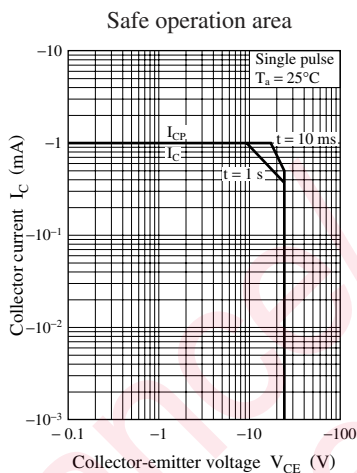
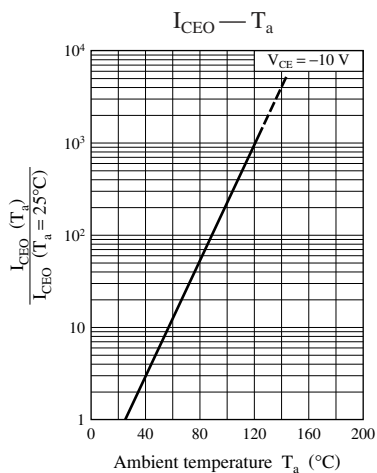
2. \*1: Pulse measurement

\*2: Rank classification

Rank	Q	R	S
$h_{FE1}$	80 to 170	120 to 240	170 to 340







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 maintenance type  
 planned discontinued type  
 discontinued type  
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